

NOTE:

1. MATERIAL, HOUSING: HIGH TEMP THERMAL PLASTIC, UL94-VO

TERMINAL: COPPER ALLOY

2. FINISH:

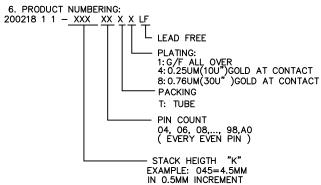
TERMINAL: GOLD AT CONTACT,
G/F OVER 1UM(40u")MIN NI OVER ALL

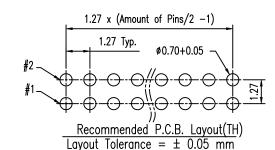
3. SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1517

4. THE HSG. WILL WITHSTAND EXPOSURE TO 260C

PEAK TEMP. FOR 10 SEC. IN A WAVE SOLDER APPLICATION.

5. MATING SIDE LENGTH: 2.5MM MIN.





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								.XXX ± 0.15			$\oplus \circlearrowleft$		VT, TH										
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Mouser Electronics

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